



For Immediate Release

Photo Stencil to Offer Process Seminars Prior to 2008 U.S. Senior Open Championship

COLORADO SPRINGS, Colorado – June 24, 2008 – Photo Stencil, a proud supporter of the 2008 U.S. Senior Open, will be conducting a series of printing process and stencil technology seminars during the week of the golf championship. The first round of this national event begins July 31, and the final round is held on Sunday, August 3 at the Broadmoor in Colorado Springs. Morning seminars will be held on July 30, 31, and August 1, and attendees are invited to the U.S. Senior Open courtesy of Photo Stencil.

Each day, Wednesday through Friday, a facility tour commences at 8:00 am, followed by a process seminar from 8:30 to 10:30. On July 30, the first part of the class will review printing process basics and parameters. The second half concentrates on stencil design and applications. The July 31 class covers lead-free process implications and intrusive reflow for tin/lead and lead-free solder. The final class, on August 1, presents independent research on print performance of various stencil technologies, such as electroform, laser, and laser with electropolish/nickel plating. Squeegee blade design and applications and print process troubleshooting are also reviewed.

At the end of each session, Photo Stencil personnel will be on hand for open discussion and one-on-one consultation. Attendees are invited to review their “problem boards” and process challenges with the company’s engineers.

The classes are held at Photo Stencil, 4725 Centennial Boulevard, Colorado Springs, Colorado. There is no charge for the seminars, and attendees will be provided with courtesy passes to the U.S. Senior Open. This national championship is conducted by the United States Golf Association (USGA). For additional information and reservations, contact Photo Stencil at (719) 599-4305. Visit the U.S. Senior Open website at www.ussenioropen.com. For product information, visit www.photostencil.com.

###

About Photo Stencil

Photo Stencil is a leading full-service provider of high-performance stencils and tooling for the surface mount technology (SMT) assembly industry. Their innovations include the patented AMTX E-FAB[®] electroformed stencils, the high-performance, proprietary NicAlloy[™] stencil, laser-cut stencils and chem-etch stencils. Step or multi-level stencils are offered in all three technologies. Stencil design support and customer-specific design libraries are also provided.

Photo Stencil's comprehensive portfolio of related products includes a complete line of squeegee blades, featuring the patented, electroformed E-Blade[®], and tooling products, such as thick film and metal mask screens.

Headquartered in Colorado Springs, Photo Stencil was founded in 1979 and currently holds many patents, trademarks, and proprietary technologies. The company has additional manufacturing facilities in Mexico and Malaysia. For more information, visit www.photostencil.com.

AMTX E-FAB, E-Blade and NicAlloy are trademarks of Photo Stencil.

Photo Stencil Contact:

Keith Favre, President and CEO
kfavre@photostencil.com
719-599-4305

Media Contact:

Bob Schreitmueller
Apogee Business Consulting, LLC
bob@ReachApogee.com